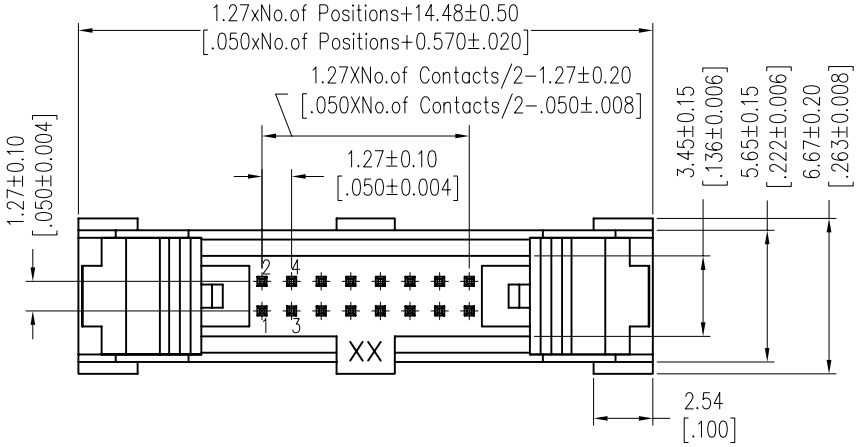
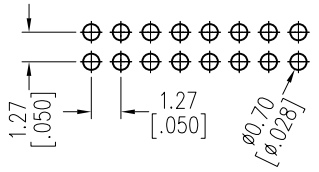
HSF

NOTES:
Current Rating: 1.75AMP
Contact Resistance: 20mΩ Max
Withstand Voltage: 1000V AC/DC
Insulation Resistance: 5000MΩ Min
Operation Temperature: −55℃ to +125℃

Contact Material: Brass
Contact plating: Au Or Sn over Ni
Insulator Material: LCP+30%G.F UL94V-0



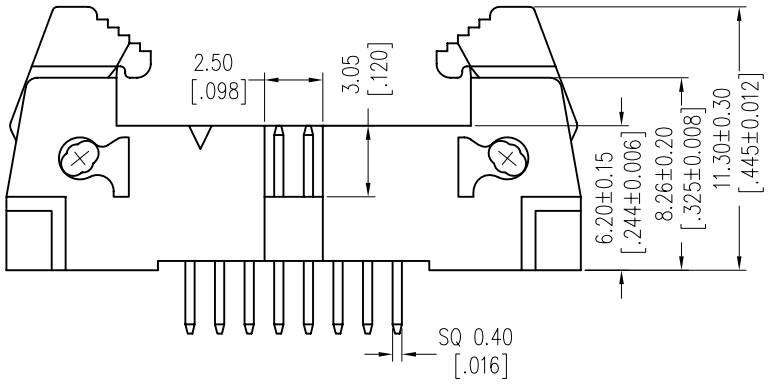
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

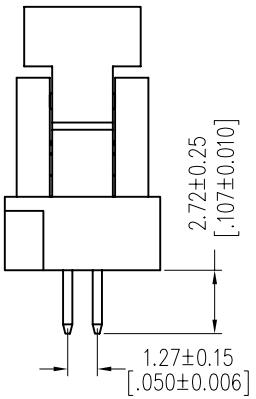


Ordering Information

3231-XX S XX B S T 1

No.of Pins	Contact Plating	Insulator Color	Packing
06 26	G0=Gold Flash	B=Black	T=Tube
08 30	G3=10u"Gold		
10 34	G4=15u"Gold		
14 40	G5=30u"Gold		
16 44	S0=Gold Flash/Tin		
20 50	S3=10u"Gold/Tin		
24	S4=15u"Gold/Tin		
	S5=30u"Gold/Tin		
	SN=Tin		





Item	Pitch	Mating
Standard	1.27	5232
Alternate		

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012/09/28	NEW	------

OPERATION		DRAW	DATE
X.X	±0.40	JYHuang	2012/09/28
X.XX	±0.25	CHECK	DATE
X.XXX	±0.15		
Angle	± 3°	APPROVE	DATE
DIM	TOL		

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

PART NO.
3231-XXSXXBST1

TITLE:
1.27 Ejector Header "S" Type 180°

Customer NO.